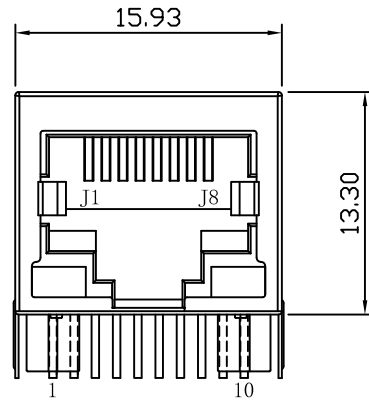
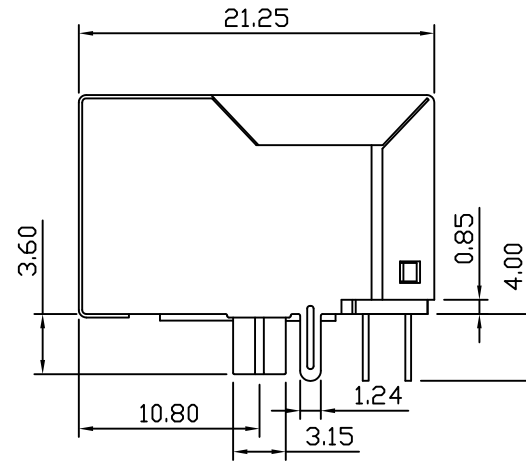


Mechanical:

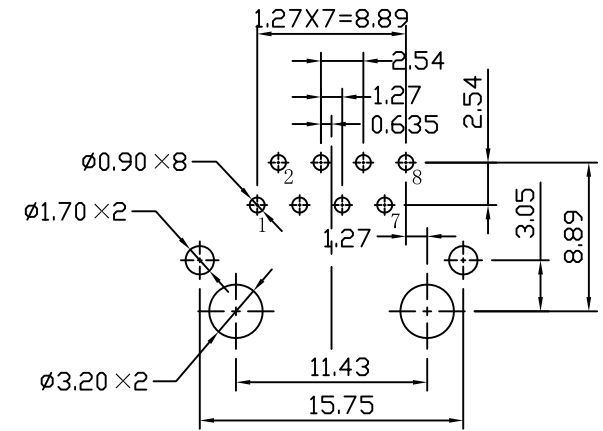
REV.	ECN NO.	DESCRIPTION	DATE	APPD
A	REL		2010/11/11	



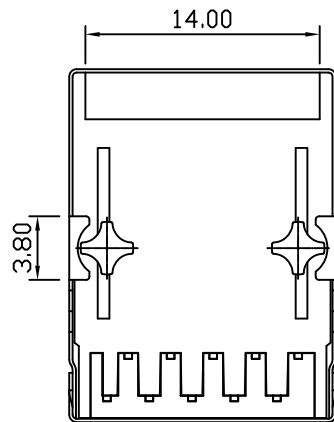
Front Side View



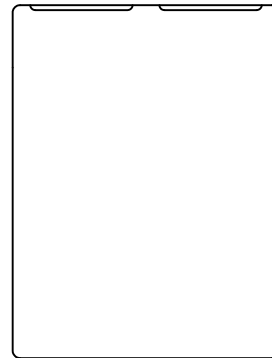
Left Side View



Suggested PCB Layout (Top View)



Bottom Side View



Top Side View

PCB JACK Electrical:

1. Insulation Resistance: 500 Megohms Min@500VDC.
 2. Dielectric Strength: 1000VAC RMS 50Hz 1Min.
 3. Operating: 750 Cycles Min.
 4. Plating Gold Thickness:
Gold Flash/1.5U"/3U"/6U"/15U"/30U" /50U"
 5. Wave solder tip temperature: 265°C Max
Wave solder tip temperature time: 5 Sec Max.
 6. UL Certification: File Number E484635.
- Environmental:
1. Storage: -40°C ~ +85°C.
 2. Operation: -40°C ~ +85°C.



X:X	±0.30	APPD:	LINK-PP INT'L TECHNOLOGY CO., LIMITED	
X:XX	±0.25	CHKD:	TITLE: RJ45 1×1 CONNECTOR	
X:XXX	±0.05	DR: TOM	PART NO.: LPJE1606DNL	
ANGLES	±1°	UNIT: mm	DWG NO.: LP10111140	
	SCALE: 2/1	SHEET: 1/1	REV: A	